



2815

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re the Application of:

Stearns et al.

Serial No.: 09/678,318

Filed: 10/03/00

**For: OPTIMIZED CIRCUIT DESIGN LAYOUT FOR HIGH
PERFORMANCE BALL GRID ARRAY PACKAGES**

Docket: TI-25833.1

Art Unit: 2815

Examiner: TBD

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Jackie McBride
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